**NICHIA CORPORATION** 

# **SPECIFICATIONS FOR UV LED**

# NCSU276AT-P1

- Pb-free Reflow Soldering Application
- Built-in ESD Protection Device
- RoHS Compliant



# **SPECIFICATIONS**

(1) Absolute Maximum Ratings

	Item	Symbol	Absolute Maximum Rating	Unit
	Forward Current	${ m I}_{\sf F}$	700	mA
11275	Pulse Forward Current	${ m I}_{\sf FP}$	1000	mA
U375	Power Dissipation	$P_{D}$	2.87	W
	Junction Temperature	Tյ	110	°C
	Forward Current	${ m I}_{\sf F}$	700	mA
11205	Pulse Forward Current	${ m I}_{\sf FP}$	1000	mA
U395	Power Dissipation	$P_{D}$	2.87	W
	Junction Temperature	Tı	130	°C
Allowable Reverse Curr	ent	${ m I}_{\sf R}$	85	mA
Operating Temperature		$T_{opr}$	-10~85	°C
Storage Temperature		$T_{stq}$	-40~100	°C

<sup>\*</sup> Absolute Maximum Ratings at  $T_S=25$ °C.

(2) Initial Electrical/Optical Characteristics

I	Item		Condition	Тур	Max	Unit
	Forward Voltage	$V_{F}$	I <sub>F</sub> =500mA	3.55	-	V
11275	Radiant Flux	Фе	I <sub>F</sub> =500mA	510	-	mW
U375	Peak Wavelength	λp	I <sub>F</sub> =500mA	375	-	nm
	Spectrum Half Width	Δλ	I <sub>F</sub> =500mA	9.0	-	nm
	Forward Voltage	$V_{F}$	I <sub>F</sub> =500mA	3.5	-	V
U395	Radiant Flux	Фе	I <sub>F</sub> =500mA	640	-	mW
	Peak Wavelength	λp	I <sub>F</sub> =500mA	395	-	nm
	Spectrum Half Width	Δλ	I <sub>F</sub> =500mA	12	-	nm
Thermal Resistance		$R_{\theta JS}$	-	14.4	17.5	°C/W

<sup>\*</sup> Characteristics at  $T_S$ =25°C.

<sup>\*</sup>  $I_{\text{FP}}$  conditions with pulse width  $\leq\!10\text{ms}$  and duty cycle  $\leq\!10\%.$ 

<sup>\*</sup> Radiant Flux value as per CIE 127:2007 standard.

<sup>\*</sup>  $R_{\theta \text{\scriptsize JS}}$  is Thermal Resistance from junction to  $T_S$  measuring point.

st It is recommended to operate the LEDs at a current greater than 10% of the sorting current to stabilize the LED characteristics.

#### RANKS

Item	Rank	Min	Max	Unit	
	M2	3.9	4.1		
E 137 II	Lk2	3.6	3.9	V	
Forward Voltage	Lk1	3.3	3.6	V	
	K2	3.1	3.3		
	P37d22	990	1080		
	P37d21	910	990		
	P36d22	835	910		
	P36d21	765	835		
	P35d22	700	765		
Radiant Flux	P35d21	640	700	\A/	
Radiant Flux	P34d22	590	640	mW	
	P34d21	540	590		
	P33d22	495	540		
	P33d21	455	495		
	P32d22	415	455		
	P32d21	380	415		
Dook Wayalangth	U395	390	400	nm	
Peak Wavelength	U375	370	380	nm	

\* Ranking at  $T_S=25$ °C.

\* Forward Voltage Tolerance: ±0.05V

\* Radiant Flux Tolerance: ±6%

\* Peak Wavelength Tolerance: ±3nm

\* LEDs from the above ranks will be shipped.

The rank combination ratio per shipment will be decided by Nichia.

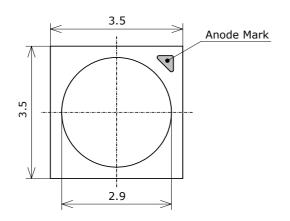
Radiant Flux Ranks by Peak Wavelength

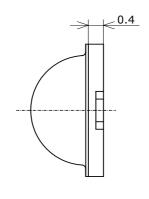
Ranking by	P32d21	P34d21	P36d21
Radiant Flux	P32d22	P34d22	P36d22
Ranking by	P33d21	P35d21	P37d21
Peak Wavelength	P33d22	P35d22	P37d22
U375			
U395			

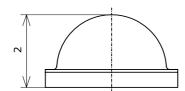
# **OUTLINE DIMENSIONS**

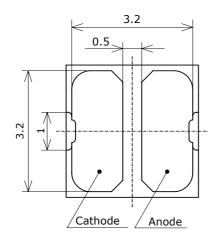
\* 本製品はRoHS指令に適合しております。 This product complies with RoHS Directive. NCSU276A-P1 管理番号 No. STS-DA7-6805

(単位 Unit: mm, 公差 Tolerance: ±0.2)

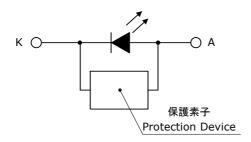






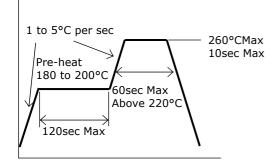


項目 Item	内容 Description
パッケージ材質	セラミックス
Package Materials	Ceramics
封止樹脂材質 Encapsulating Resin Materials	シリコーン樹脂 Silicone Resin
電極材質	金メッキ
Electrodes Materials	Au-plated
レンズ材質	シリコーン樹脂
Lens Materials	Silicone Resin
質量 Weight	0.030g (TYP)

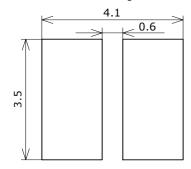


### **SOLDERING**

• Recommended Reflow Soldering Condition(Lead-free Solder)



• Recommended Soldering Pad Pattern



(単位 Unit: mm)

- \* This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, Nichia cannot guarantee its reliability.
- \* Reflow soldering must not be performed more than twice.
- \* Avoid rapid cooling. Ramp down the temperature gradually from the peak temperature.
- \* Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.
- \* Since the silicone used in the encapsulating resin is soft, do not press on the encapsulant resin.

  Pressure can cause nicks, chip-outs, encapsulant delamination and deformation, and wire breaks, decreasing reliability.

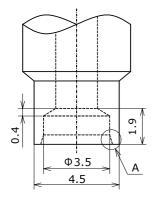
  When using automatic pick and place machine, use a pick up nozzle which does not directly apply stress to the encapsulation of the LEDs.

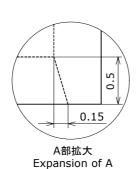
#### Recommended conditions:

Using a nozzle designed for the LEDs is recommended. (See Figure below)

\* The nozzle must not have any direct contact with the encapsulating resin.

Direct contact with the encapsulating resin may result in internal disconnections causing the LED not to illuminate.



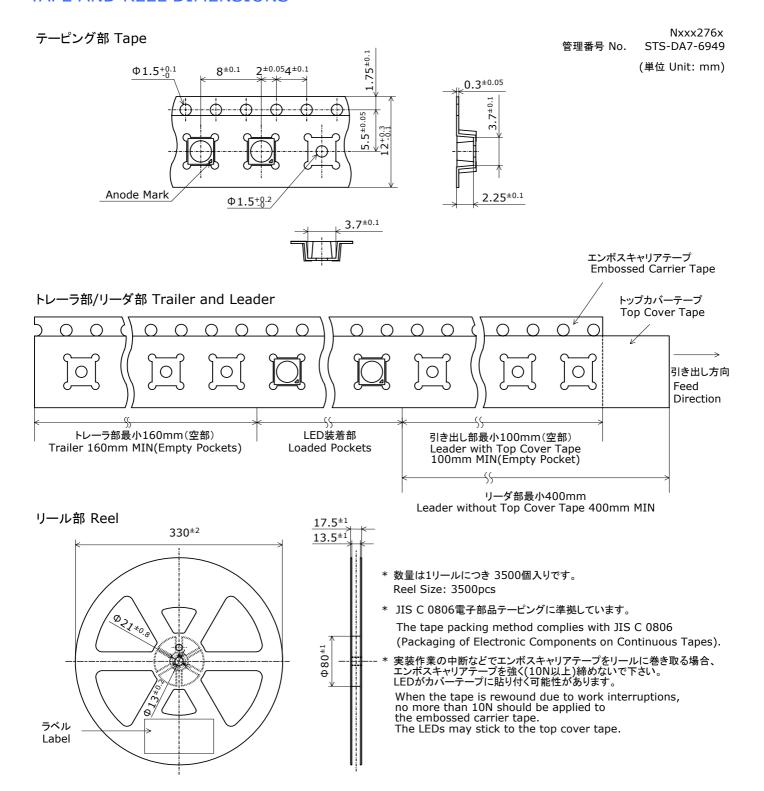


(単位 Unit: mm)

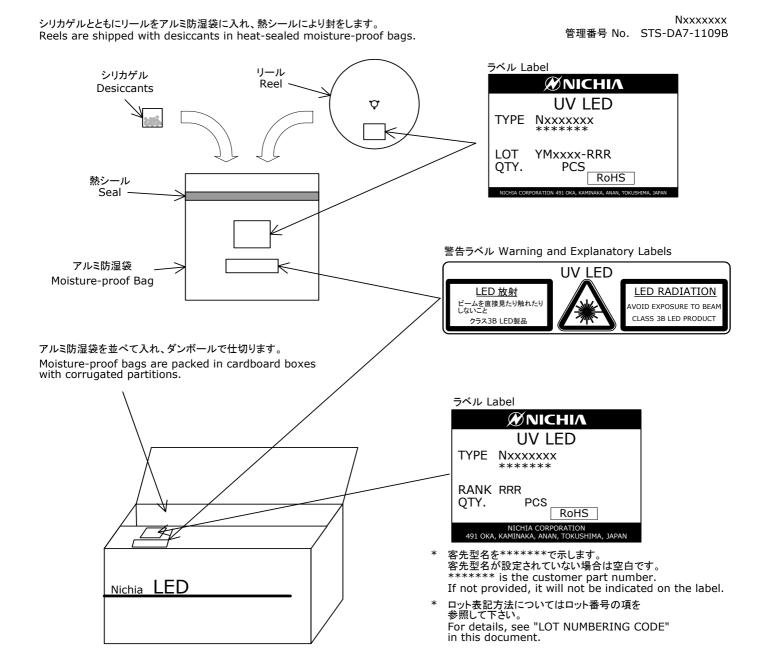
- $\ensuremath{^{*}}$  Repairing should not be done after the LEDs have been soldered.
  - It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- \* When soldering, do not apply stress to the LED while the LED is hot.
- \* The recommended soldering pad pattern is designed for attachment of the LED without problems.

  When precise mounting accuracy is required, such as high-density mounting, ensure that the size and shape of the pad are suitable for the circuit design.
- \* When flux is used, it should be a halogen free flux. Ensure that the manufacturing process is not designed in a manner where the flux will come in contact with the LEDs.
- \* Make sure that there are no issues with the type and amount of solder that is being used.

### TAPE AND REEL DIMENSIONS



### PACKAGING - TAPE & REEL



- \* 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
  Products shipped on tape and reel are packed in a moisture-proof bag.
  They are shipped in cardboard boxes to protect them from external forces during transportation.
- \* 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。 Do not drop or expose the box to external forces as it may damage the products.
- \* ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。 Do not expose to water. The box is not water-resistant.
- \* 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。
  Using the original package material or equivalent in transit is recommended.

# LOT NUMBERING CODE

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Y
2013	D
2014	E
2015	F
2016	G
2017	Н
2018	I

M - Month

Month	М	Month	М
1	1	7	7
2	2	8	8
3	3	9	9
4	4	10	Α
5	5	11	В
6	6	12	С

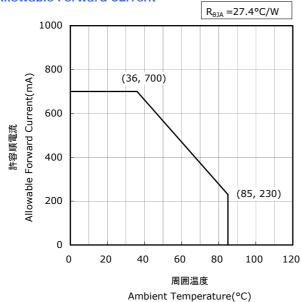
xxxx-Nichia's Product Number

RRR-Ranking by Wavelength, Ranking by Radiant Flux, Ranking by Forward Voltage

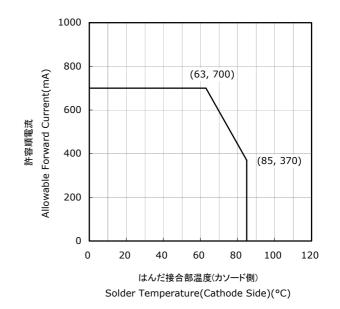
NCSU276A-P1 管理番号 No. STS-DA7-6795

### 周囲温度-許容順電流特性

**Ambient Temperature vs Allowable Forward Current** 

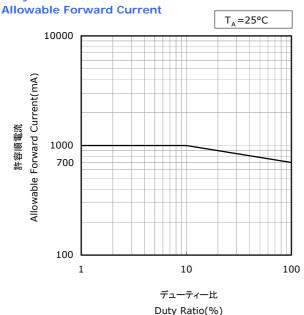


はんだ接合部温度(カソード側)-許容順電流特性 Solder Temperature(Cathode Side) vs Allowable Forward Current



#### デューティー比-許容順電流特性

**Duty Ratio vs** 



\* 本特性はピーク波長ランクU375に対応しています。
The graphs above show the characteristics for U375 LEDs of this product.

# **DERATING CHARACTERISTICS**

NCSU276A-P1 管理番号 No. STS-DA7-6796

### 周囲温度-許容順電流特性

**Ambient Temperature vs** 

R<sub>θJA</sub> =27.4°C/W

1000

800

(57, 700)

(85, 430)

40

60

周囲温度

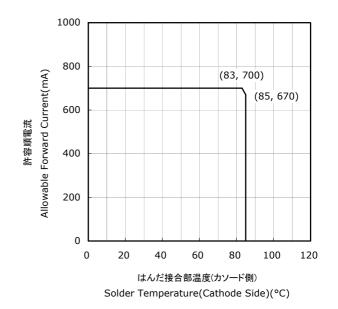
Ambient Temperature(°C)

80

100

120

はんだ接合部温度(カソード側)-許容順電流特性 Solder Temperature(Cathode Side) vs Allowable Forward Current



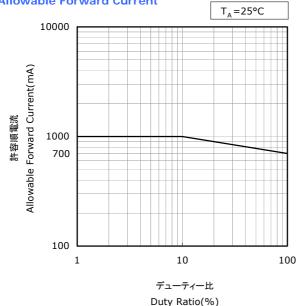
#### デューティー比-許容順電流特性

0

0

20

Duty Ratio vs Allowable Forward Current

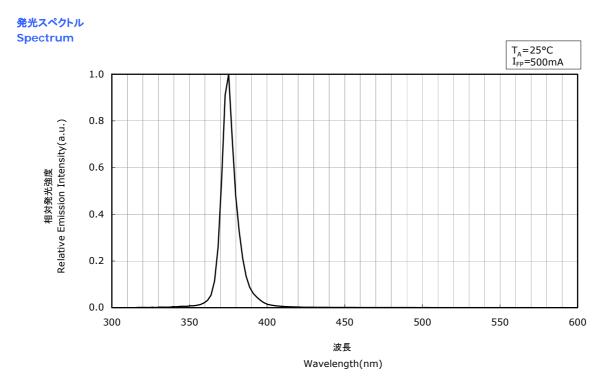


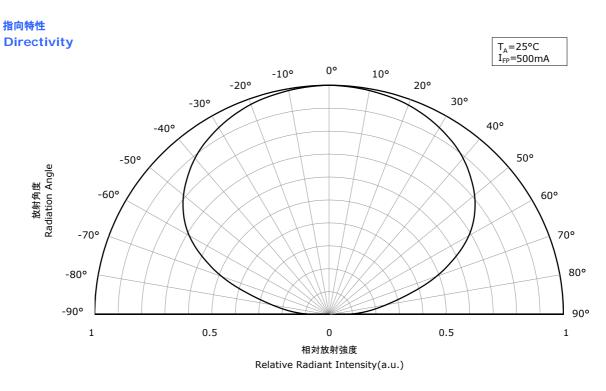
\* 本特性はピーク波長ランクU395に対応しています。

The graphs above show the characteristics for U395 LEDs of this product.

# OPTICAL CHARACTERISTICS

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NCSU276A-P1 管理番号 No. STS-DA7-6797

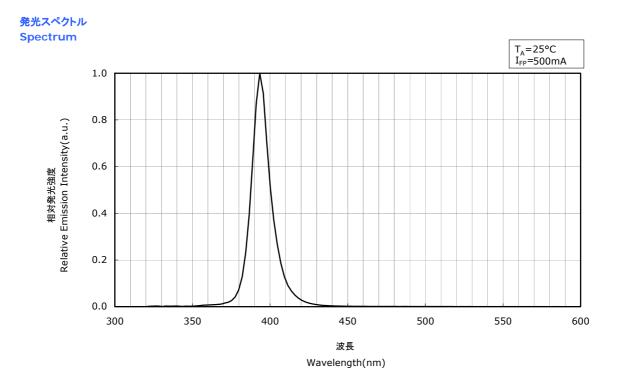


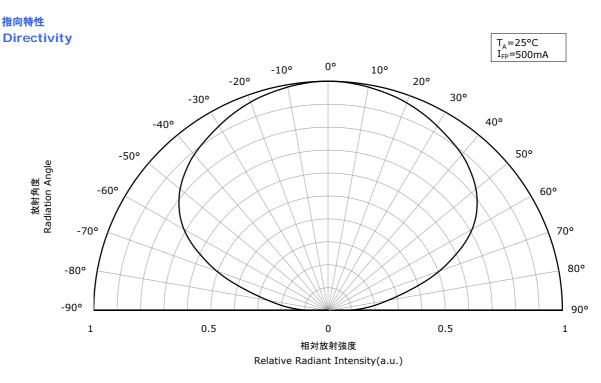


\* 本特性はピーク波長ランクU375に対応しています。
The graphs above show the characteristics for U375 LEDs of this product.

# OPTICAL CHARACTERISTICS

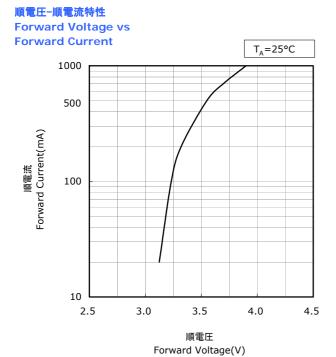
\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NCSU276A-P1 管理番号 No. STS-DA7-6798

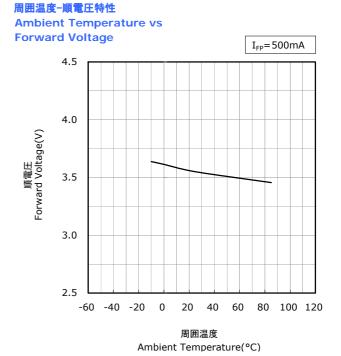




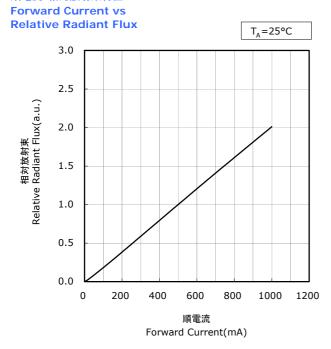
\* 本特性はピーク波長ランクU395に対応しています。
The graphs above show the characteristics for U395 LEDs of this product.

\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NCSU276A-P1 管理番号 No. STS-DA7-6799

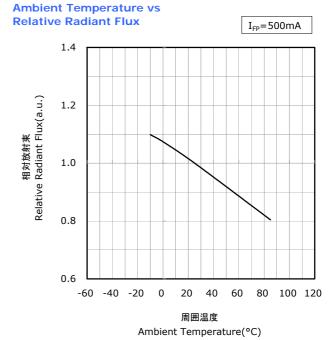




### 順電流-相対放射束特性







\* 本特性はピーク波長ランクU375に対応しています。
The graphs above show the characteristics for U375 LEDs of this product.

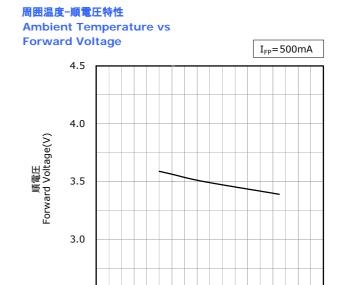
\* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed.

NCSU276A-P1 管理番号 No. STS-DA7-6800

80 100 120



Forward Current(mA) 100 10 3.5 2.5 3.0 4.0 4.5 順電圧 Forward Voltage(V)

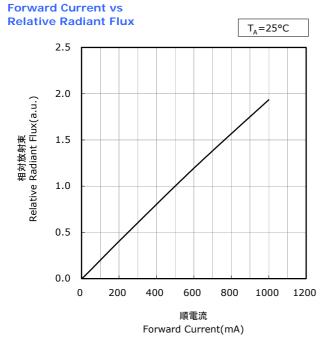


0 20 40 60

周囲温度

Ambient Temperature(°C)

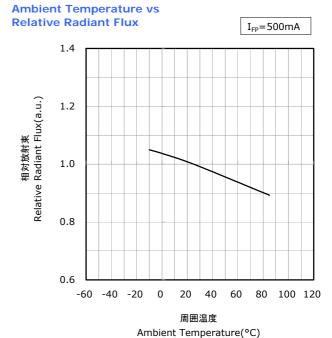




### 周囲温度-相対放射束特性

2.5

-60 -40 -20

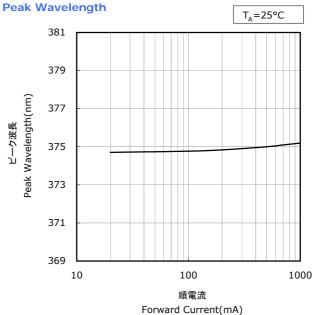


本特性はピーク波長ランクU395に対応しています。 The graphs above show the characteristics for U395 LEDs of this product.

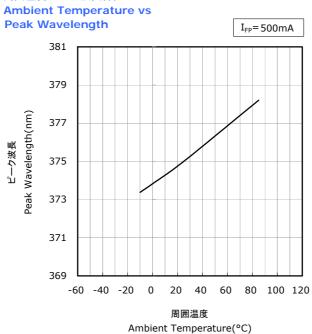
\* 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.

NCSU276A-P1 管理番号 No. STS-DA7-6801





#### 周囲温度-ピーク波長特性

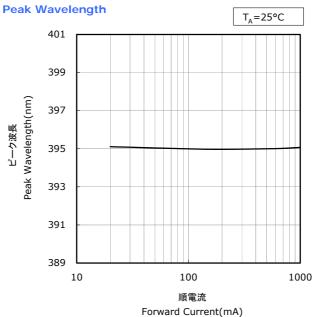


\* 本特性はピーク波長ランクU375に対応しています。 The graphs above show the characteristics for U375 LEDs of this product.

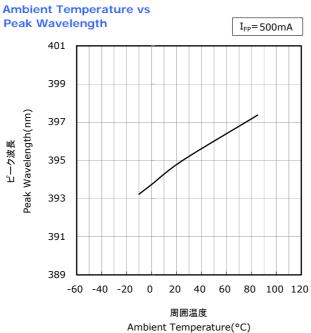
\* 本特性は参考です。
All characteristics shown are for reference only and are not guaranteed.

NCSU276A-P1 管理番号 No. STS-DA7-6802

順電流-ピーク波長特性 Forward Current vs Peak Wavelength



#### 周囲温度-ピーク波長特性



\* 本特性はピーク波長ランクU395に対応しています。 The graphs above show the characteristics for U395 LEDs of this product.

# **RELIABILITY**

# (1) Tests and Results

	Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
	nce to ng Heat v Soldering)	JEITA ED-4701 300 301	T <sub>sld</sub> =260°C, 10sec, 2reflows, Precondition: 30°C, 70%RH, 168hr		#1	0/10
Temper	rature Cycle	JEITA ED-4701 100 105	-40°C(30min)~25°C(5min)~ 100°C(30min)~25°C(5min)	100cycles	#1	0/10
High Te Storage	emperature e	JEITA ED-4701 200 201	T <sub>A</sub> =100°C	1000hours	#1	0/10
Low Ter	mperature e	JEITA ED-4701 200 202	T <sub>A</sub> =-40°C	1000hours	#1	0/10
Room T Operati Condition	_		T <sub>A</sub> =25°C, I <sub>F</sub> =500mA	1000hours	#1	0/10
Room T Operati Condition	_		T <sub>A</sub> =25°C, I <sub>F</sub> =700mA	1000hours	#1	0/10
U375	High Temperature		T <sub>A</sub> =85°C, I <sub>F</sub> =200mA	1000hours	#1	0/10
U395	Operating Life		T <sub>A</sub> =85°C, I <sub>F</sub> =350mA	1000hours	#1	0/10
Temper Operati	rature Humidity ing Life		60°C, RH=90%, I <sub>F</sub> =350mA	500hours	#1	0/10
Low Tei Operati	mperature ing Life		T <sub>A</sub> =-10°C, I <sub>F</sub> =500mA	1000hours	#1	0/10
JEITA ED-4701 200m/s², 100-		200m/s², 100~2000~100Hz, 4cycles, 4min, each X, Y, Z	48minutes	#1	0/10	
Electros	JEITA ED-4701 HBM, 2kV, 1.5kΩ, 100pF, 3pulses,				#1	0/10

### NOTES:

- 1) R<sub>θJA</sub>≈27.4°C/W
- 2) Measurements are performed after allowing the LEDs to return to room temperature.

### (2) Failure Criteria

Criteria #	Items	Conditions	Failure Criteria
	Forward Voltage(V <sub>F</sub> )	I <sub>F</sub> =500mA	>Initial value×1.1
#1	Radiant Flux( $\Phi_{E}$ )	I <sub>F</sub> =500mA	<initial td="" value×0.7<=""></initial>

### **CAUTIONS**

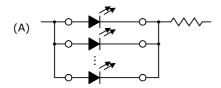
(1) Storage

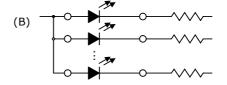
	Conditions	Temperature	Humidity	Time
	Before Opening Aluminum Bag	≤30°C	≤90%RH	Within 1 Year from Delivery Date
Storage	After Opening Aluminum Bag	≤30°C	≤70%RH	≤168hours
Baking		65±5°C	-	≥24hours

- Product complies with JEDEC MSL 3 or equivalent. See IPC/JEDEC STD-020 for moisture-sensitivity details.
- Absorbed moisture in LED packages can vaporize and expand during soldering, which can cause interface delamination
  and result in optical performance degradation. Products are packed in moisture-proof aluminum bags
  to minimize moisture absorption during transportation and storage.
  - Included silica gel desiccants change from blue to red if moisture had penetrated bags.
- After opening the moisture-proof aluminum bag, the products should go through the soldering process within the range of the conditions stated above. Unused remaining LEDs should be stored with silica gel desiccants in a hermetically sealed container, preferably the original moisture-proof bags for storage.
- After the "Period After Opening" storage time has been exceeded or silica gel desiccants are no longer blue, the products should be baked. Baking should only be done once.
- Although the leads or electrode pads (anode and cathode) of the product are plated with gold,
  prolonged exposure to a corrosive environment might cause the gold plated the leads or electrode pads to tarnish,
  and thus leading to difficulties in soldering. If unused LEDs remain, they must be stored in a hermetically sealed container.
   Nichia recommends using the original moisture-proof bag for storage.
- Do not use sulfur-containing materials in commercial products. Some materials, such as seals and adhesives, may contain sulfur. The contaminated plating of LEDs might cause an open circuit. Silicone rubber is recommended as a material for seals. Bear in mind, the use of silicones may lead to silicone contamination of electrical contacts inside the products, caused by low molecular weight volatile siloxane.
- To prevent water condensation, please avoid large temperature and humidity fluctuations for the storage conditions.
- Do not store the LEDs in a dusty environment.
- Do not expose the LEDs to direct sunlight and/or an environment where the temperature is higher than normal room temperature.

#### (2) Directions for Use

When designing a circuit, the current through each LED must not exceed the Absolute Maximum Rating.
 Operating at a constant current per LED is recommended. In case of operating at a constant voltage, Circuit B is recommended.
 If the LEDs are operated with constant voltage using Circuit A, the current through the LEDs may vary due to the variation in Forward Voltage characteristics of the LEDs.





- This product should be operated using forward current. Ensure that the product is not subjected to either forward or reverse voltage while it is not in use. In particular, subjecting it to continuous reverse voltage may cause migration, which may cause damage to the LED die. When used in displays that are not used for a long time, the main power supply should be switched off for safety.
- It is recommended to operate the LEDs at a current greater than 10% of the sorting current to stabilize the LED characteristics.
- Ensure that excessive voltages such as lightning surges are not applied to the LEDs.
- For outdoor use, necessary measures should be taken to prevent water, moisture and salt air damage.
- This LED also emits visible light. Please take notice of visible light spectrum, in case you use this LED as light source of sensors etc.

#### (3) Handling Precautions

- Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LED to be deformed and/or the wire to break, which will cause the LED not to illuminate.
- When handling the product with tweezers, be careful not to apply excessive force to the resin.

  Otherwise, The resin can be cut, chipped, delaminate or deformed, causing wire-bond breaks and catastrophic failures.
- Dropping the product may cause damage.
- Do not stack assembled PCBs together. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed. It may cause wire to break, leading to catastrophic failures.

### (4) Design Consideration

- Although Nichia recommends using a copper PCB for this product, customer is advised to verify the PCB with the products before use. Stress during soldering can cause the glass lens to break and/or the solder joints to crack.
- PCB warpage after mounting the products onto a PCB can cause the package to break.

  The LED should be placed in a way to minimize the stress on the LEDs due to PCB bow and twist.
- The position and orientation of the LEDs affect how much mechanical stress is exerted on the LEDs placed near the score lines.

  The LED should be placed in a way to minimize the stress on the LEDs due to board flexing.
- Board separation must be performed using special jigs, not using hands.
- If an aluminum PCB is used, customer is advised to verify the PCB with the products before use. Thermal stress during use can cause the solder joints to crack.
- When substances commonly found in ink adhere to the resin of this product, it may reduce the radiant flux and may change the material properties. Materials, such as dustproof glass, should be used to protect the LEDs.

#### (5) Electrostatic Discharge (ESD)

• The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability.

When handling the products, the following measures against electrostatic discharge are strongly recommended:

Eliminating the charge

Grounded wrist strap, ESD footwear, clothes, and floors

Grounded workstation equipment and tools

ESD table/shelf mat made of conductive materials

- Ensure that tools, jigs and machines that are being used are properly grounded and that proper grounding techniques are used in work areas. For devices/equipment that mount the LEDs, protection against surge voltages should also be used.
- If tools or equipment contain insulating materials such as glass or plastic,

the following measures against electrostatic discharge are strongly recommended:

Dissipating static charge with conductive materials

Preventing charge generation with moisture

Neutralizing the charge with ionizers

The customer is advised to check if the LEDs are damaged by ESD
when performing the characteristics inspection of the LEDs in the application.

Damage can be detected with a forward voltage measurement at low current (≤1mA).

• ESD damaged LEDs may have current flow at a low voltage.

Failure Criteria:  $V_F$ <2.0V at  $I_F$ =0.5mA

#### (6) Thermal Management

- Proper thermal management is an important when designing products with LEDs. LED die temperature is affected by PCB thermal resistance and LED spacing on the board. Please design products in a way that the LED die temperature does not exceed the maximum Junction Temperature (T<sub>J</sub>).
- Drive current should be determined for the surrounding ambient temperature (TA) to dissipate the heat from the product.
- The following equations can be used to calculate the junction temperature of the products.

1)  $T_J = T_A + R_{\theta JA} \cdot W$  2)  $T_J = T_S + R_{\theta JS} \cdot W$ 

\*T<sub>J</sub>=LED junction temperature: °C

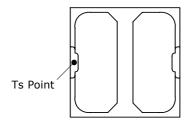
T<sub>A</sub>=Ambient temperature: °C

T<sub>S</sub>=Soldering temperature (cathode side): °C

R<sub>0JA</sub>=Thermal resistance from junction to ambient: °C/W

 $R_{\theta JS}$ =Thermal resistance from junction to  $T_S$  measuring point: °C/W

W=Input power( $I_F \times V_F$ ): W



#### (7) Cleaning

- The LEDs should not be cleaned with water, benzine, and/or thinner.
- If required, isopropyl alcohol (IPA) should be used. Other solvents may cause premature failure to the LEDs due to the damage to the resin portion. The effects of such solvents should be verified prior to use. In addition, the use of CFCs such as Freon is heavily regulated.
- When dust and/or dirt adheres to the LEDs, soak a cloth with Isopropyl alcohol (IPA), then squeeze it before wiping the LEDs.
- Ultrasonic cleaning is not recommended since it may have adverse effects on the LEDs depending on the ultrasonic power and how LED is assembled.

If ultrasonic cleaning must be used, the customer is advised to make sure the LEDs will not be damaged prior to cleaning.

#### (8) Eye Safety

• In 2006, the International Electrical Commission (IEC) published IEC 62471:2006 Photobiological safety of lamps and lamp systems, which added LEDs in its scope.

On the other hand, the IEC 60825-1:2007 laser safety standard removed LEDs from its scope.

However, please be advised that some countries and regions have adopted standards

based on the IEC laser safety standard IEC 60825-1:20112001, which still includes LEDs in its scope.

Most of Nichia's LEDs can be classified as belonging into either the Exempt Group or Risk Group 1.

High-power LEDs, that emit light containing blue wavelengths, may be classified as Risk Group 2.

Please proceed with caution when viewing directly any LEDs driven at high current, or viewing LEDs with optical instruments which may greatly increase the damages to your eyes.

- Viewing a flashing light may cause eye discomfort. When incorporating the LED into your product, please be careful to avoid adverse effects on the human body caused by light stimulation.
- The products are UV light LEDs, and radiate intense UV light during operation. Since UV light can be harmful to eyes, do NOT look directly into the UV light, even through an optical instrument. In case of the light reflection, UV protective glasses are required to use in order to avoid damage by the light.

### (9) Others

- The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances).
   Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control system, automobiles, traffic control equipment, life support systems and safety devices).
- The customer shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the customer shall inform Nichia directly before disassembling or analysis.
- The specifications and appearance of this product may change without notice;

  Nichia does not guarantee the contents of this specification. Both the customer and Nichia

  will agree on the official specifications of supplied products before the volume production of a program begins.